

MIL-T-152B  
 AMENDMENT-2  
6 JUNE 1966  
 Superseding  
 Amendment 1  
 24 August 1962

MILITARY SPECIFICATION  
 TREATMENT, MOISTURE AND FUNGUS-RESISTANT,  
 OF COMMUNICATIONS, ELECTRONIC,  
 AND ASSOCIATED ELECTRICAL EQUIPMENT

This amendment forms a part of Military Specification MIL-T-152B, 31 March 1961, and is mandatory for use by all Departments and Agencies of the Department of Defense.

Page 1, paragraph 2.1

SPECIFICATION

MILITARY - add

MIL-I-46058, "Insulating Compound, Electrical (For Coating Printed Circuit Assemblies)."

Page 1, paragraph 3.1 - At end of paragraph add sentence, "The statement of treatment is not required when Specification MIL-I-46058 is specified. "(See 3.3.2 (b) 18)".

Page 2, paragraph 3.3.2 (b) 16 - Delete in its entirety and substitute, "Plastic materials of the following types: polyacetal, polyamide, polycarbonate, polyethylene, polypropylene, polystyrene, acrylic, silicone, epoxy, melamine-fiberglass, fluorocarbon, vinyl, and alkyd."

Page 3, paragraph 3.3.2 (b) add: "18. Printed Circuit Assemblies, treated with coating conforming to Specification MIL-I-46058, or other coating approved by the Procuring Activity. The items specified in paragraph 3.3.2 shall be protected against the application of MIL-I-46058, or other approved printed circuit coating."

Page 3, paragraph 3.3.3.2 type II - limited treatment: In last sentence delete "3.3.3.2.1 and," add "Unless specified otherwise, soldered connections shall be treated in accordance with paragraph 3.3.3.2.1."

Page 7, paragraph 6.3, add to (k) and (l) "(fungus-resistant grade only)  
 add: (q) Polyacetal - (fungus-resistant grade only)  
 (r) Polycarbonate  
 (s) Polypropylene"

Custodians:

Army - EL  
 Navy - WP  
 Air Force - 11

Preparing Activity:

Army - EL

Review Activities:

Army - EL, MR, MU, WC  
 Navy - WP  
 Air Force - 11

Project MISC-0332

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